





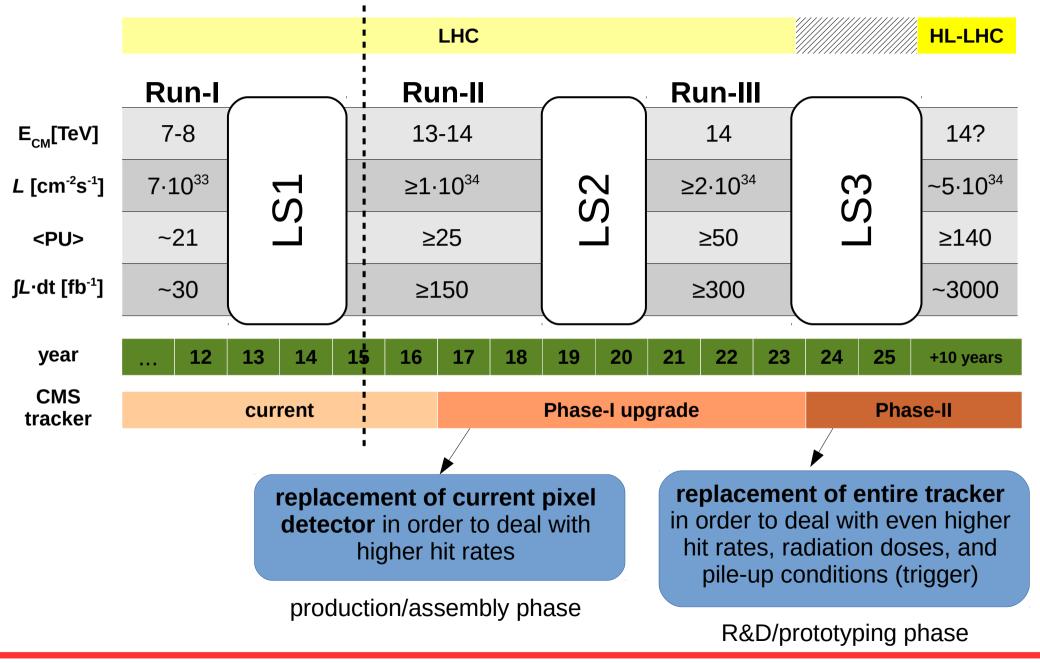
Benedikt Vormwald

Hamburg University on behalf of the CMS collaboration

EPS-HEP 2015

Vienna, 22.-29.07.2015

CMS Tracker Upgrade Program

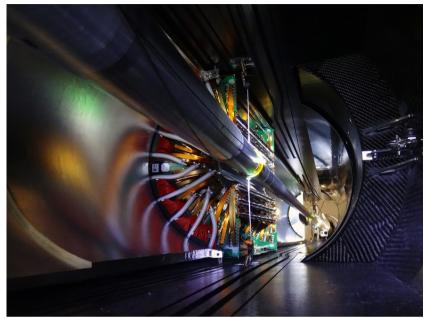


Current CMS Pixel Detector

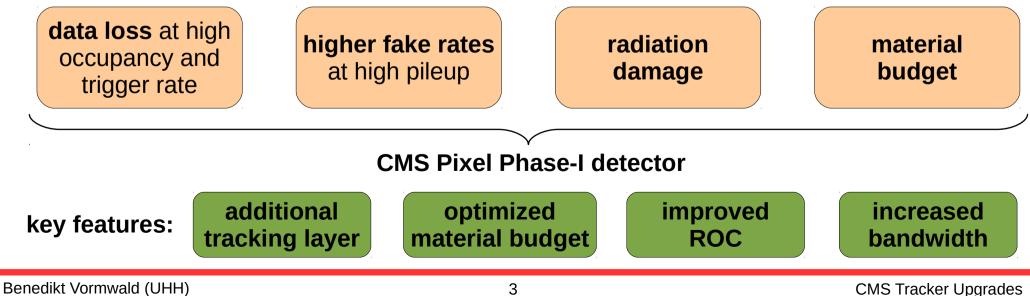
Status of present pixel detector

- present pixel detector has performed extremely well during LHC Run-I:
 - resolution: $r-\phi$: 10µm, z: 20µm-40µm
 - efficiency: $\varepsilon > 99\%$
- designed for
 - integrated luminosity: *[L*·dt = 500 fb⁻¹
 - instantaneous luminosity:
 - → $L = 1.10^{34} \text{ cm}^{-2} \text{s}^{-1} @ 25 \text{ ns}$
 - \rightarrow pile-up events: **PU> = 25**
 - → in 2012: <PU> = 35 @ 50ns

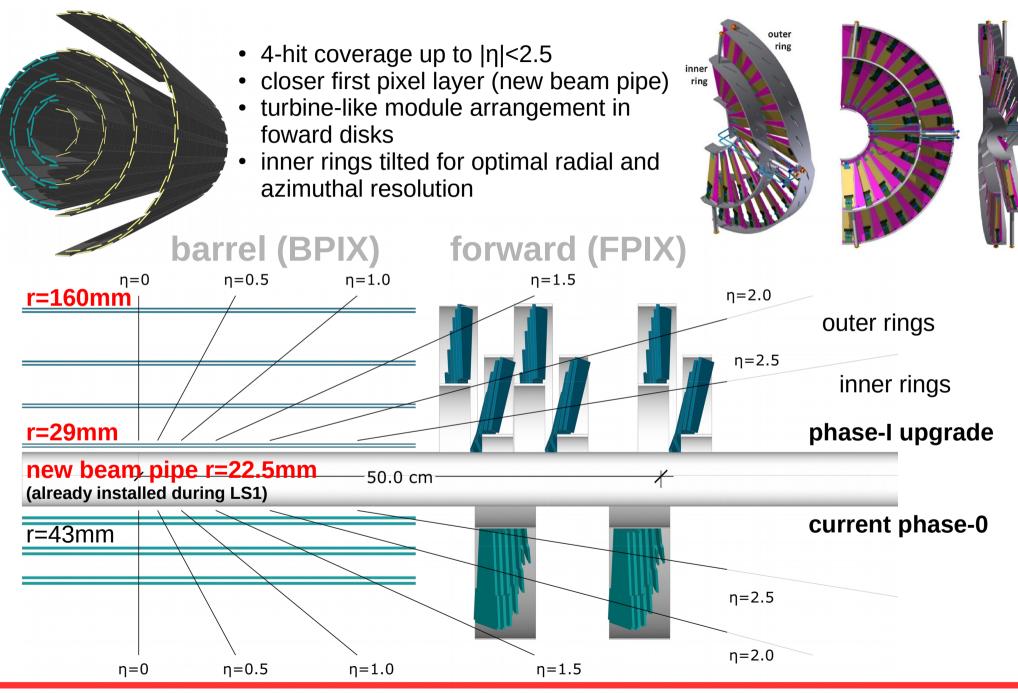
becomes relevant before LS3



Performance limitations



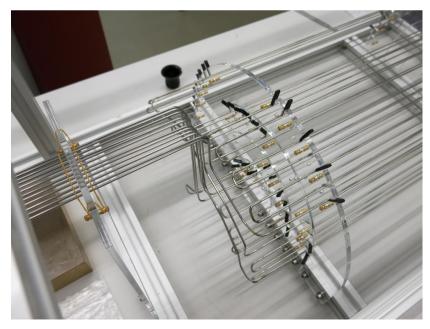
CMS Phase-I Pixel Detector – Geometry

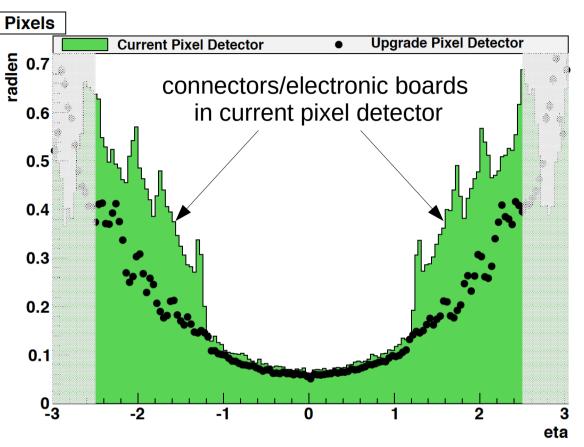


CMS Phase-I Pixel Detector – Material Budget

despite additional tracking layer: material further reduced

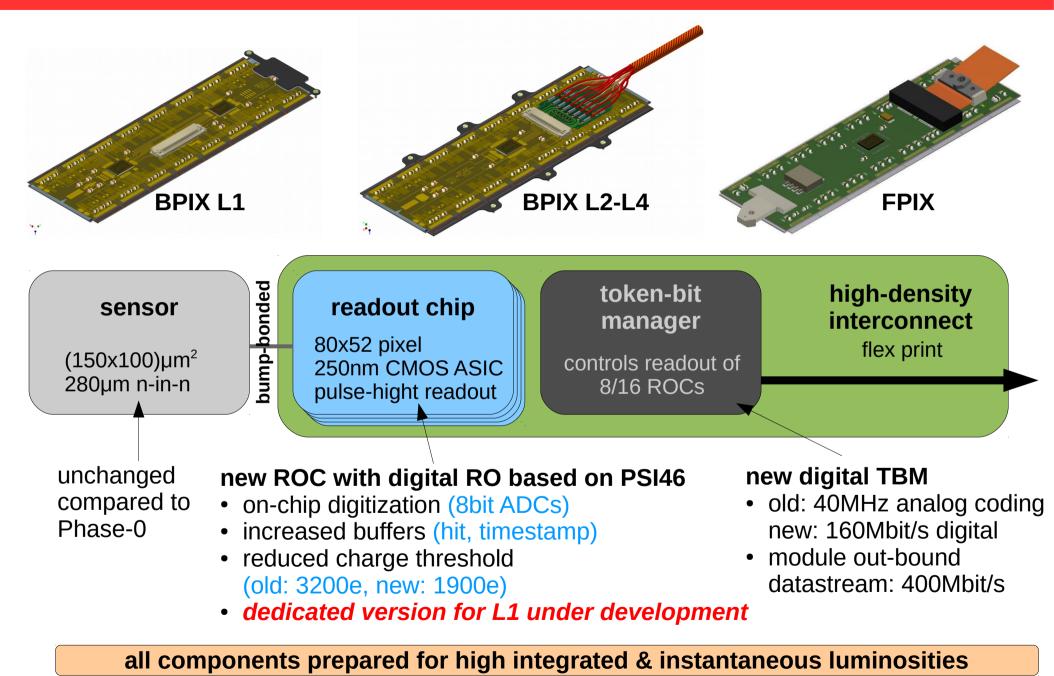
- electronic boards/connectors moved to higher η
- lightweight support structures
 - BPIX: CFRP/Airex foam compound with cooling loops as backbone
 - FPIX: graphite ring Thermo Pyrolytic Graphite (TPG) for blades



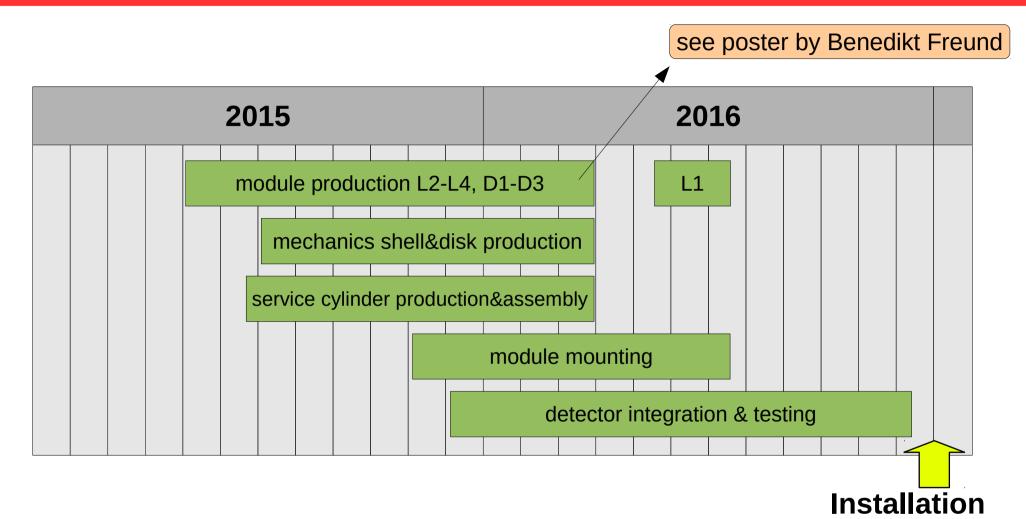


- 2-phase CO₂ cooling
 - → -20°C, option to go deeper
 - → very lightweight
 - stainless steel cooling loops: diameter 1.6mm, wall thickness 50µm
 - cooling plant installed and commissioned during LS1

CMS Phase-I Pixel Detector – Modules



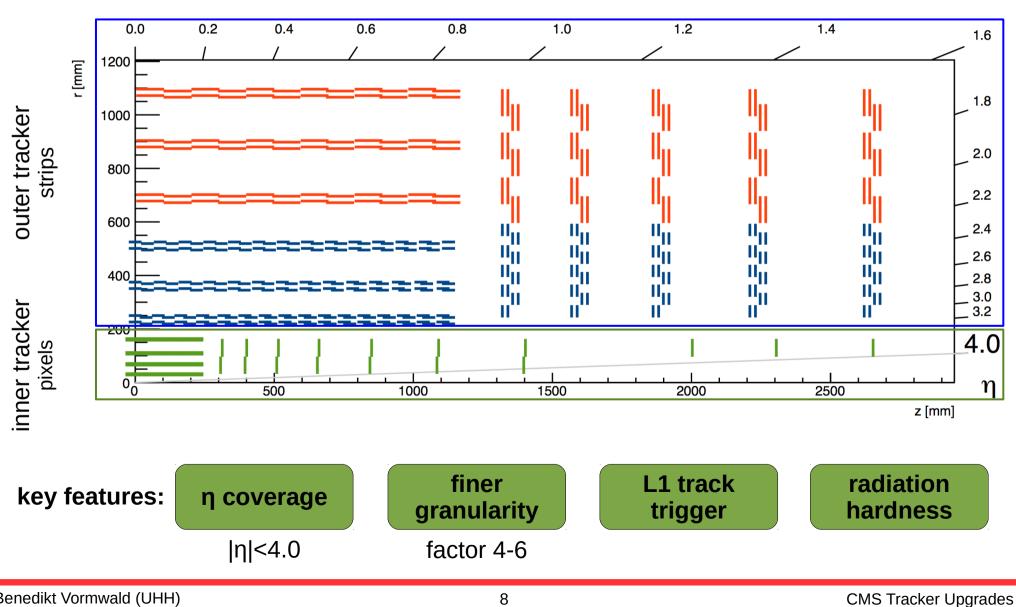
CMS Phase-I Pixel Detector – Towards Installation





CMS Phase-II Tracker

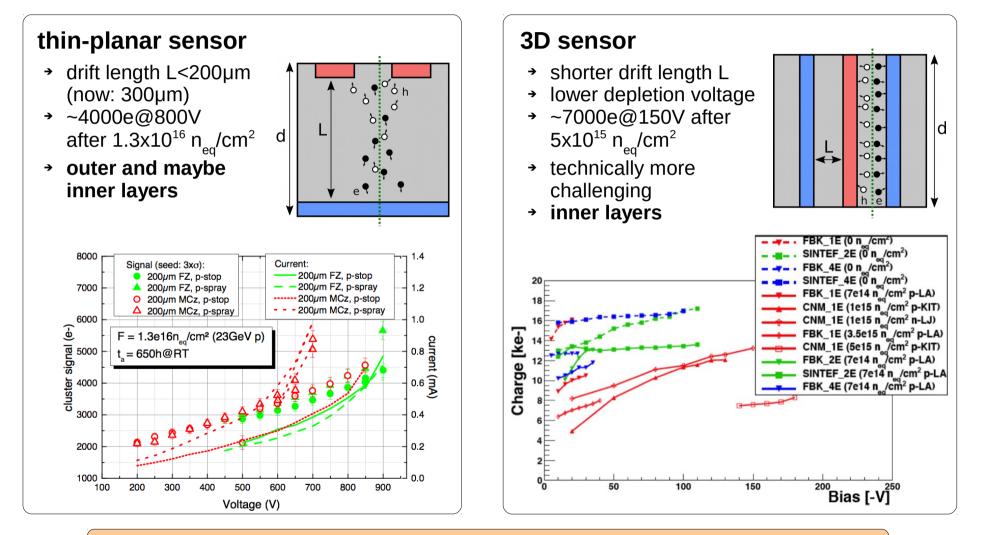
2025-2035: CMS gets a completely new inner and outer tracker for HL-LHC



Benedikt Vormwald (UHH)

CMS Phase-II Tracker – Pixel Sensor Options

- expected fluence: $\sim 2 \times 10^{16} n_{eq}^{2} / cm^{2}$ in first layer
- charge trapping reduces signal cluster charge and thus single hit efficiency
- solution: reduce drift distance

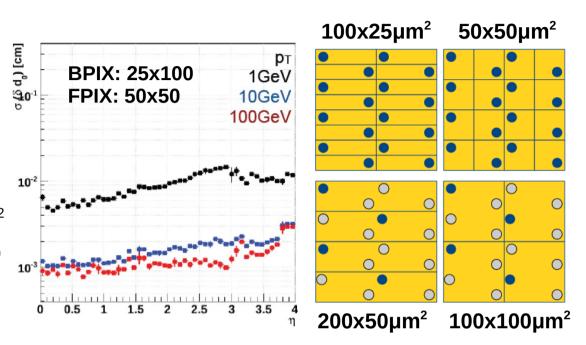


final decision based on **performance**, **radiation tolerance**, **cost/yield**

CMS Phase-II Tracker – Pixel Size and Readout

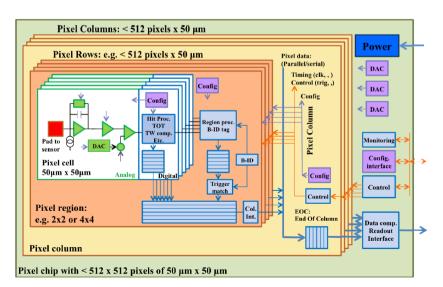
Pixel size

- affects
 - → two-track separation
 - → detector occupancy
 - → high- p_{T} -track resolution
- factor 6 smaller pixels: (50x50)µm² or (25x100)µm² current pixel detector: (150x100)µm²
- option: different pixel aspect ratio, larger pixels in different parts of detector using the same ROC



Readout chip

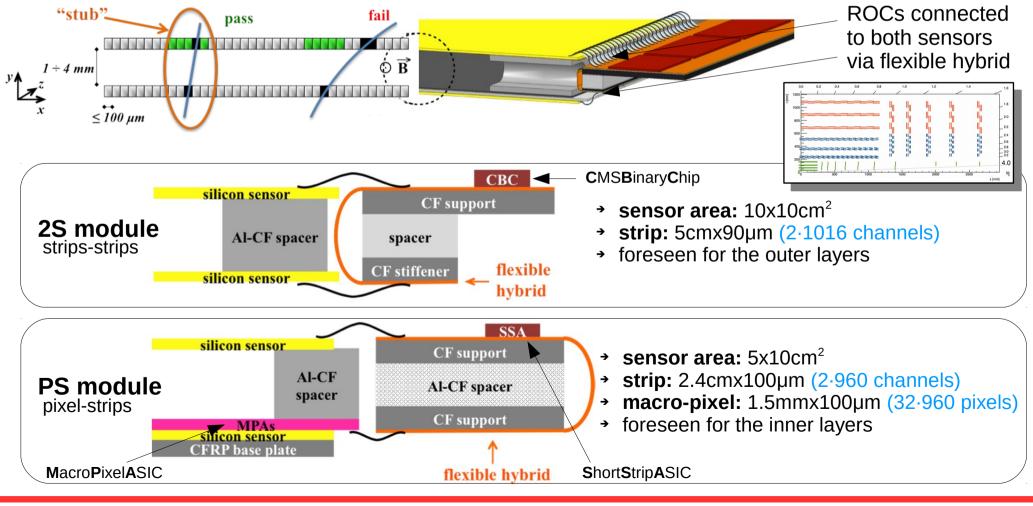
- RD53 Collaboration (20 institutes, CMS+ATLAS) develops demonstrator chip for 2016
- 65nm CMOS technology
 - Iow power
 - → radiation tolerant (up to 1Grad)
- larger hit rate (2GHz/cm²)
- increased trigger rate/latency (1MHz/12.5µs)
- low effective threshold (~1000e)



CMS Phase-II Tracker – Outer Tracker Modules

Concept of p_{τ} modules

- calorimeter and muon-based triggers alone will no longer be sufficient to reduce rates due to PU and limited spatial resolution
- track information needed on L1 trigger level
- use hits in two close sensor-layers in magnetic field to filter high- p_{τ} -hits



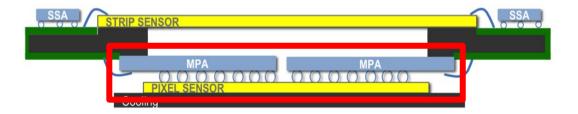
CMS Phase-II Tracker – Outer Tracker Prototyping

Early 2S prototype

- mini 2S prototype built in 2013
- 2xCBC chip
- stub-finding logic
- nominal noise/threshold
- beam test at DESY in Dec 2013 and at CERN in Jun 2015



- scaled down version of the macro-pixel part of the PS module
- MacroPixelSubAssembly
- MPA light chip
 - → 16x3 (full: 120x16) pixel
- PS-p light sensor
 - → material: FZ p-type (200µm)
 - → 48x6 pixel
 - → size: 7.8x12mm²



Efficiency

0.8

0.6

0.4

0.2

prototyping phase for sensor and modules started schedule: finished by end of 2017 p_{T} threshold

nominal:

2.14GeV

2

measured:

(2.2±0.1)GeV

4 5 p_ (eq. @75cm) [GeV/c]

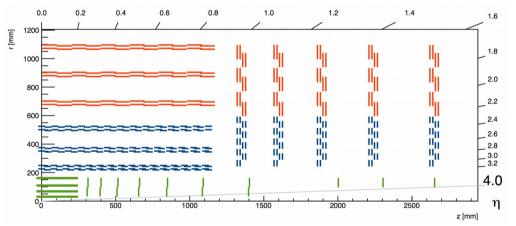
Conclusions

Phase-I Pixel Upgrade

- new 4-layer pixel detector based on new digital readout chips
- production ongoing, no obstacles in sight
- installation during LHC EYETS 2016/2017

Phase-II Tracker Upgrade

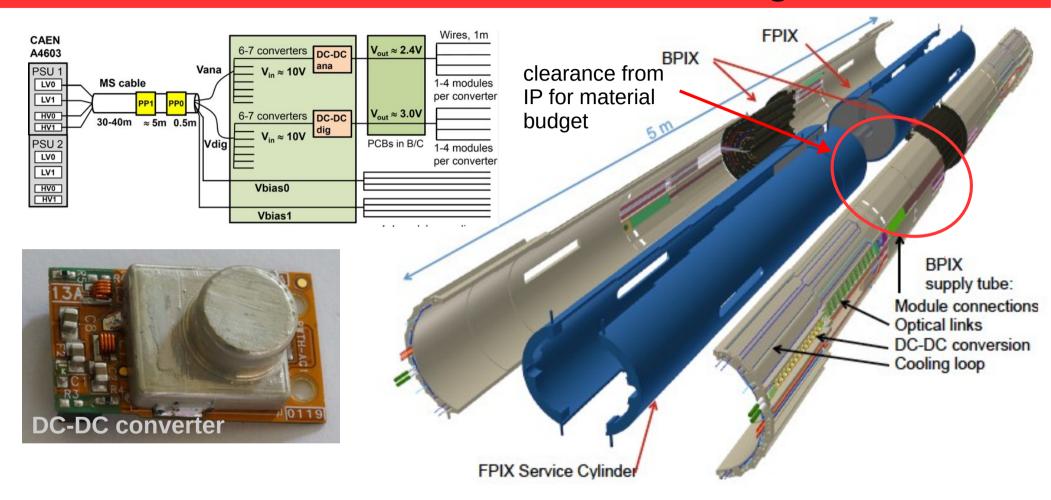
- Technical Proposal just published CERN-LHCC-2015-10
- final Pixel concept under development
- Outer Tracker concept well advanced, first prototype modules available



Rich R&D and physics program of the CMS tracker for the next 20 years!

Backup Material

CMS Phase-I Pixel Detector – Powering&Service



Powering

- 1.9 times more channels
- same power cables
- DC-DC conversion near the detector 10V to 2.4V/3.0V
- 1184 converters needed

Connection to the outside world

- design idea: modular, easy-to-access
- Supply Tube (BPIX)/Service Cylinders (FPIX) house powering, cooling lines, readout electronics
- same mechanical envelope as Phase-0

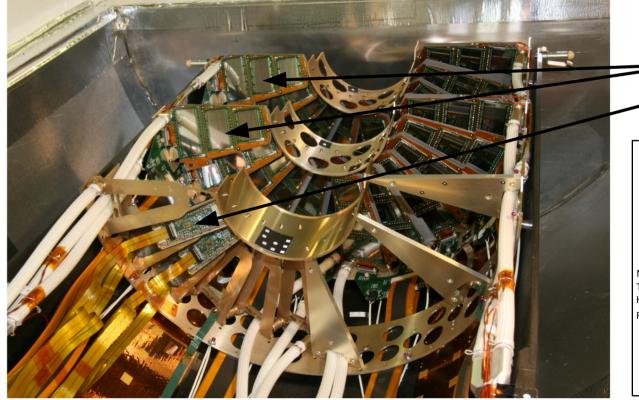
CMS Phase-I Pixel Detector – Pilot System

8 phase-I modules installed on new third FPIX disk as pilot system during LS1

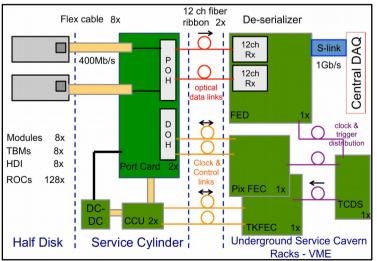
- develop and exercise full readout chain in CMS DAQ environment
- gain operation experience with new ROC/TBM

ficiency map of pilot module
ficiency m

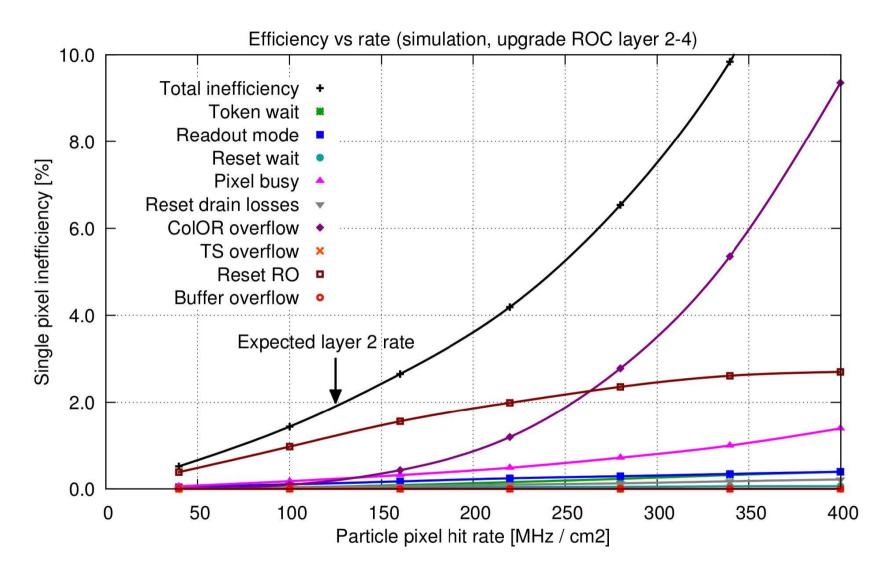
Pilt BmI D3 BLD3 PNL1 PLQ1 ROC0



Phase-0 FPIX plaquettes Phase-I FPIX module



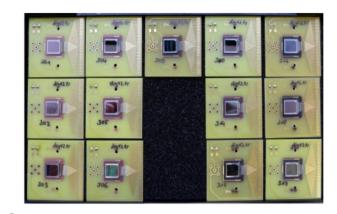
CMS Phase-I Pixel Detector – ROC Rate Capability

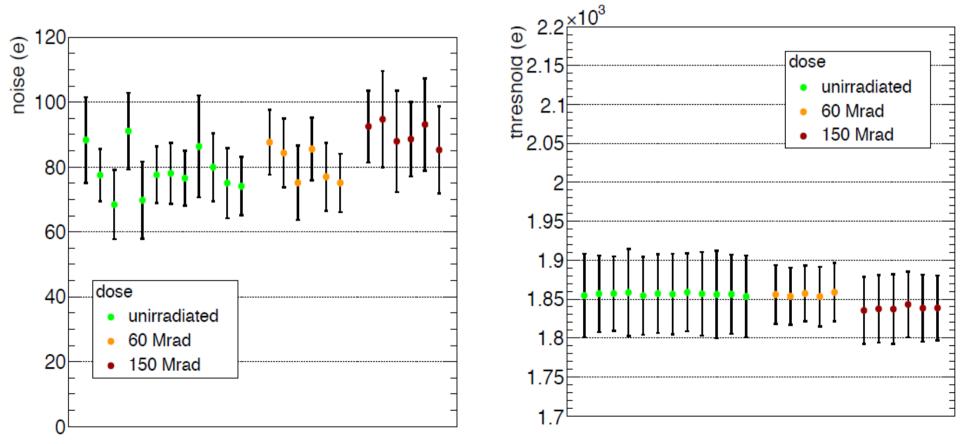


- tolerable inefficiency of <2% in BPIX L2-L4 and FPIX (<120 Mhz/cm²)
- extrapolation to BPIX L1 (up to 580 Mhz/cm²): inefficiency of >30%
- dedicated chip design in preparation

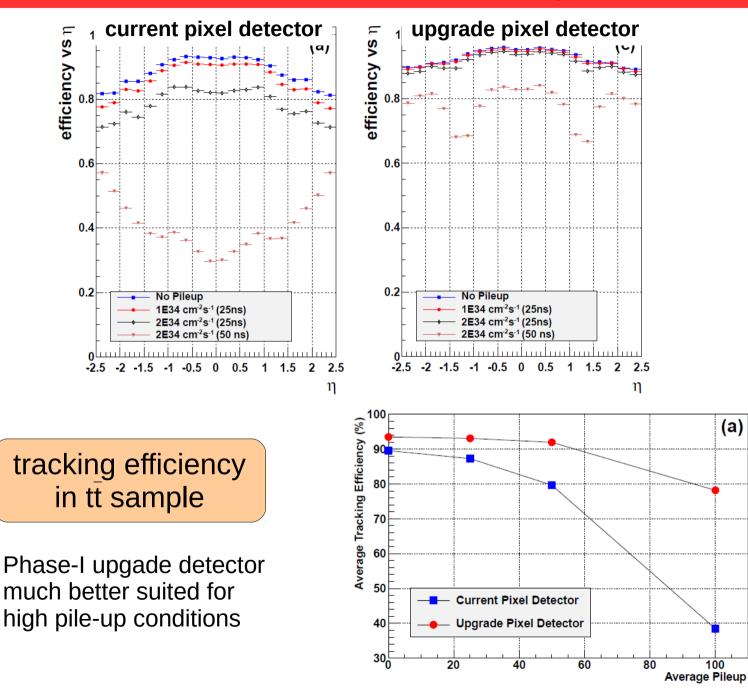
CMS Phase-I Pixel Detector – ROC Radiation Hardness

- expect 120Mrad in L1 after 500fb⁻¹
- irradiation of single chip modules (PSI46digv2.1respin) with 23MeV protons at Karlsruhe
- excelent performance after irradiation with even higher dose than expected

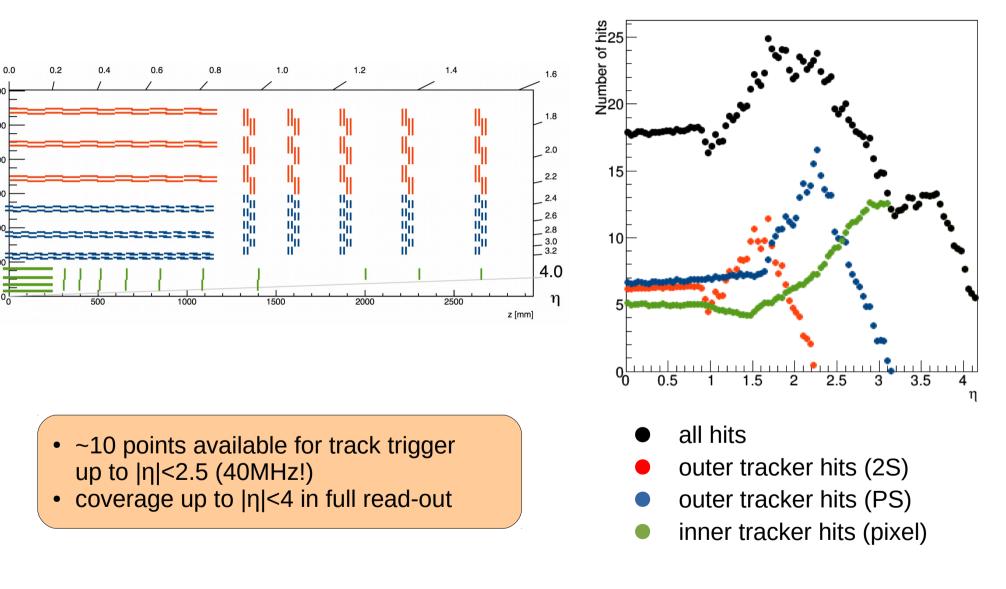




CMS Phase-I Pixel Detector – Tracking Performance



CMS Phase-II Tracker – Coverage



Number of hits

[L 1200

1000

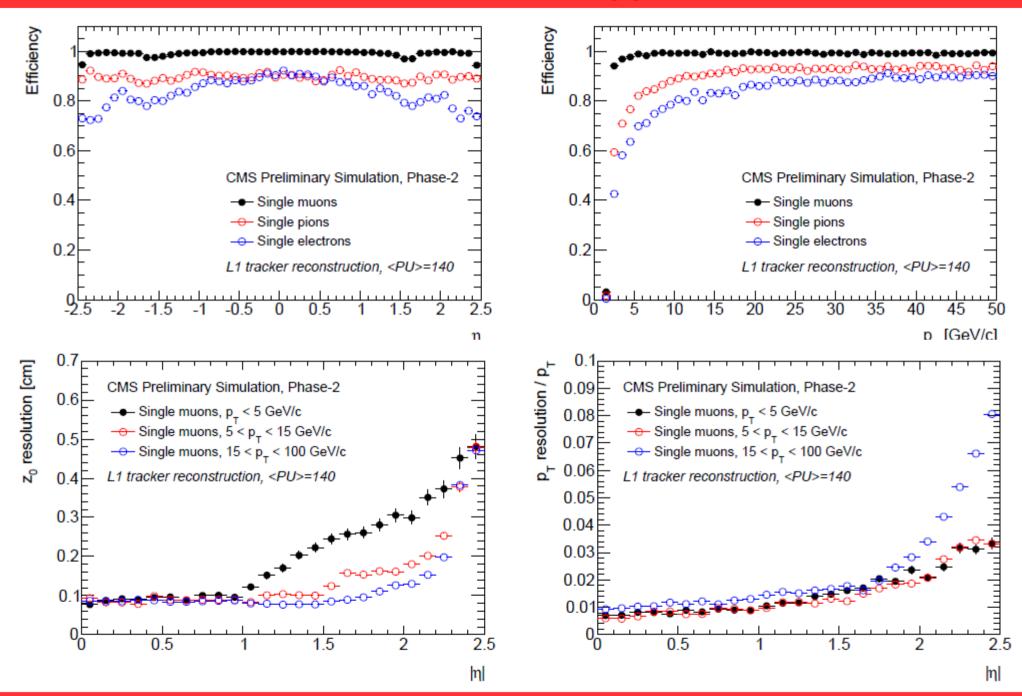
800

600

40

200

CMS Phase-II Tracker – LvI1-Trigger Performance



CMS Phase-II Tracker – Tracking Performance

